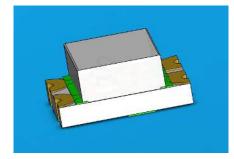


DATASHEET

SMD • B EAST1916GRA0



Features

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH
- Compliance Halogen Free .(Br <900 ppm ,Cl <900 ppm , Br+Cl < 1500 ppm).

Description

- The SMD LED is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications. etc.

Applications

- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

Device Selection Guide

Chip Materials		Emitted Color	Resin Color	Resin Color		
G6	AlGaInP	Brilliant Yellow Green				
R6	AlGaInP	Brilliant Red	Waler Clear	- Waler Clear		

Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit	
Reverse Voltage	V _R	5	V	
Forward Current	I _F	G6:25 R6:25	mA	
Peak Forward Current (Duty 1/10 @1KHz)	I _{FP}	G6:60 R6:60	mA	
Power Dissipation	Pd	G6:60 R6:60	mW	
Operating Temperature	T _{opr}	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +90	°C	
Electrostatic Discharge	ESD _{HBM}	SUR:2000 SUB:2000	V	
Soldering Temperature	T _{sol}	Reflow Soldering : 260 ${}^\circ\!\mathrm{C}$ for 10 sec. Hand Soldering : 350 ${}^\circ\!\mathrm{C}$ for 3 sec.		

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol		Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	lv	G6: R6:	22.5 45.0		57.0 90.0	mcd	
Viewing Angle	20 _{1/2}			130		deg	_
Peak Wavelength	λр	G6: R6:		575 632		nm	
Dominant Wavelength	λd	G6 R6:	; 	573 624		nm	I _F =20mA
Spectrum Radiation Bandwidth	Δλ	G6: R6:		20 20		nm	_
Forward Voltage	V _F	G6: R6:		2.0 2.0	2.4 2.4	V	_
Reverse Current	I _R	G6: R6:			10 10	μA	V _R =5V

Notes:

1. Tolerance of Luminous Intensity ±11%

Bin Range of Luminous Intensity

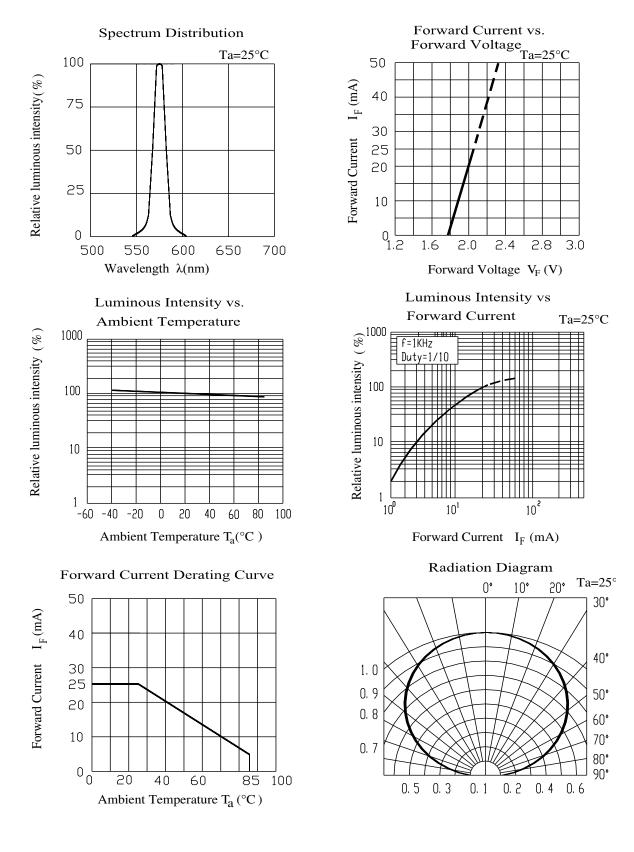
Min.	Max.	Unit	Condition
22.5	28.5		
28.5	36.0		
36.0	45.0	mcd	I _F =20mA
45.0	57.0		
Min.	Max.	Unit	Condition
45.0	57.0		
57.0	72.0	mcd	I _F =20mA
72.0	90.0		
	22.5 28.5 36.0 45.0 Min. 45.0 57.0	22.5 28.5 28.5 36.0 36.0 45.0 45.0 57.0 Min. Max. 45.0 57.0 57.0 72.0	22.5 28.5 28.5 36.0 36.0 45.0 45.0 57.0 Min. Max. Unit 45.0 57.0 57.0 72.0 mcd

Notes:

Tolerance of Luminous Intensity ±11%

Typical Electro-Optical Characteristics Curves

G6:



2.4

2.8

10

10°

0. 2

0.4

20°

3.0

Ta=25°C

Ta=25°C

30°

40°

50°

60°

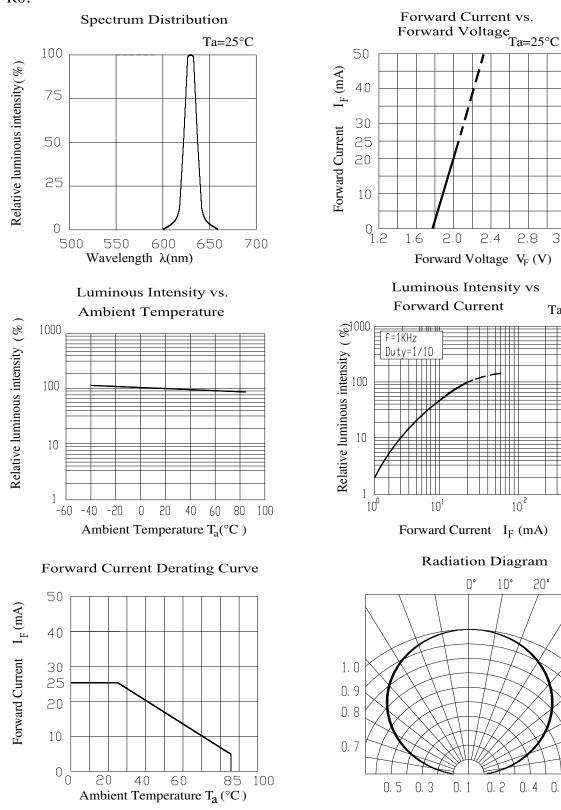
70°

80°

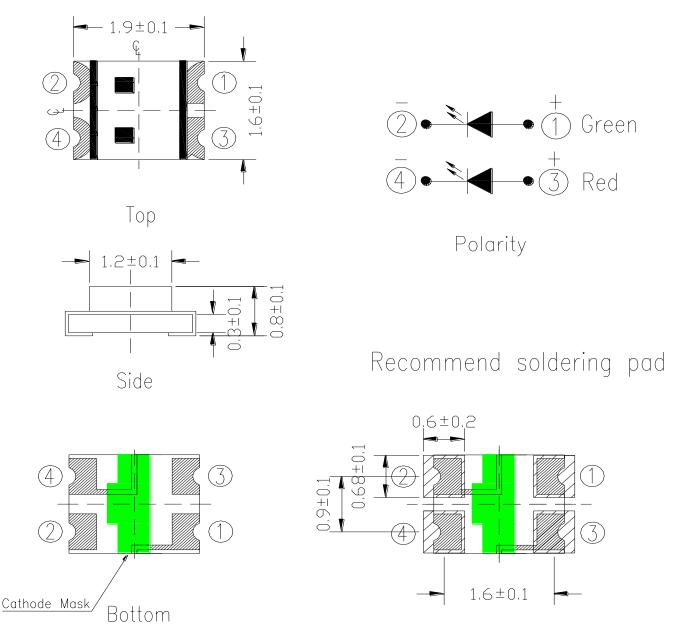
90°

0.6

Typical Electro-Optical Characteristics Curves R6:



Package Outline Dimensions



Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Note: Tolerances unless mentioned ± 0.1 mm. Unit = mm

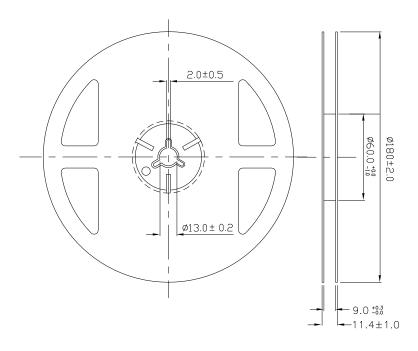
Moisture Resistant Packing Materials

Label Explanation



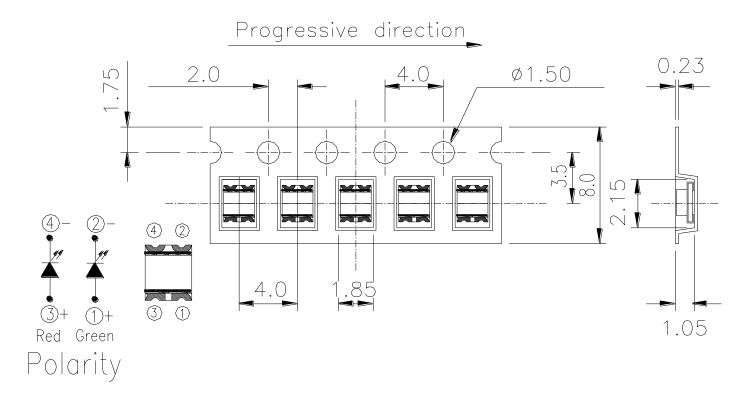
- CPN: Customer's Product Number
- P/N: Product Number
- QTY: Packing Quantity
- CAT: Luminous Intensity Rank
- HUE: Chromaticity Coordinates & Dom. Wavelength Rank
- REF: Forward Voltage Rank
- LOT No: Lot Number

Reel Dimensions



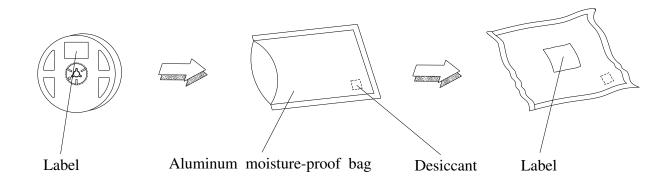
Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned is ± 0.1 mm ,Unit = mm

Moisture Resistant Packaging

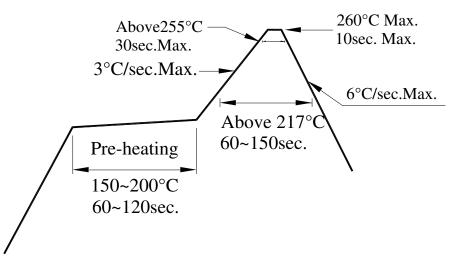


Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.
 Baking treatment : 60±5°C for 24 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



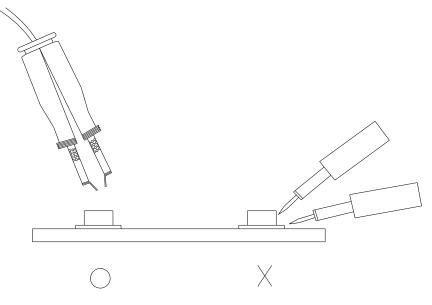
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4.Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350° C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.





Application Restrictions

High reliability applications such as military/aerospace, automotive safety/security systems, and medical equipment may require different product. If you have any concerns, please contact Everlight americas before using this product in your application. This specification guarantees the quality and performance of the product as an individual component. Do not use this product beyond the specification described in this document.